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HARDWARE NAME: MAX26240_EVKIT_A

HARDWARE NUMBER:

ENGINEER:

DESIGNER:

DATE: 07/17/2023

ODB++/GERBER: ASSEMBLY_BOTTOM

MH2

MH1

MH4

MH3



(LAYER 1) TOP SIDE
PCB BOARD
BOTTOM SIDE

REFDES: MH1, MH2, MH3, MH4

STANDOFF ASSEMBLY